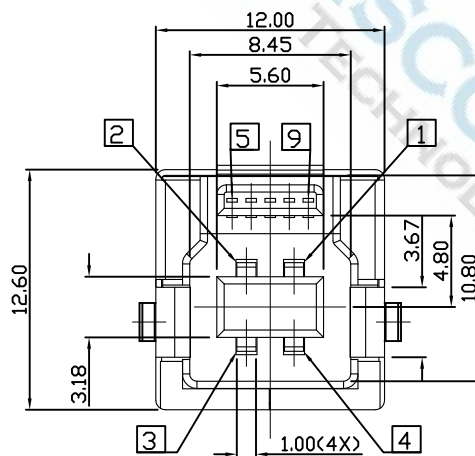


PCB LAYOUT



Note:

1.specification:

ELECTRICAL CHARACTERISTICS:
 30V DC/AC 1A Max.
 CONTACT RESISTANCE:30mΩ Max.
 INSULATION RESISTANCE:
 100M Ω Min.at 500V DC.
 DIELECTRIC STRENGTH:
 750V AC/1 minute.
 INSERTION FORCE:3.6kgf MAX
 WITHDRAWAL:1.0kgf MIN

2.Finishes:

- 2.1 Contacts: Gold flashed
 1u",3u",5u",10u",15u",30u"
- 2.2 Shell: Nickel plated.

項次	品名	數量	規格	備注
6	USB3.0-B母座立式-外殼	1	BRASS T=0.30mm FINISH:NICKEL	
5	USB3.0-B母座立式-后塞	1	High temp. thermoplastic UL 94V-0	
4	USB3.0-B母座立式-下座	1	High temp. thermoplastic UL 94V-0	
3	USB3.0-B母座立式-上座	1	High temp. thermoplastic UL 94V-0	
2	USB3.0-B母座立式-端子	4	PHOSPHOR BRONZE T=0.25mm SEE TABLE	
1	USB3.0-B母座立式-PIN 5	1	BRASS T=0.20mm SEE TABLE	

DIMENSIONS TOLERANCE	單位(UNITS)	MM	處理(FINISH)	SEE NOTE	審校(CH'K)	Calvin	圖名(NAME)		WISCONN Technology Co., Ltd Tel:02-2742-1798 Fax:02-2742-1898							
	METRIC	數量(QT'Y)	N/A	繪圖(DRAW)	Johnson	核准(APP'D)	Selena	USB3.0 B/F VERTICAL TYPE(8.0mm)								
.0=±0.30 .00=±0.20 .000=±0.10 ANG.=±2°	材料(MT'L)	SEE NOTE	設計(DE'N)	Mike	日期 DATE)	OCT.15.2007	料號(PART NUMBER)	WU3BF-09FPBUDV-8.0	比例 (SCALE)	1/1	圖紙 (SIZE)	A4	頁次 (SHEET)	1	版次 (REV.)	A